RELIABILITY TEST REPORT

TESTITEM: 1.ELECTRICAL 2.MECHANICAL 3.ENVIRONMENTAL							
SERIES NO.: CH01 Series							
TEST EQUIPMENT: 1.INSERTION & REMOVAL APPARATUS 2.ELECTRONIC MEASURING APPARATUS 3.ENVIRONMENTAL APPARATUS							
DATE OF TESTING: 11 / 17 / 03							
TEST DEPART: QA TESTER:							
CONTAINT: ATTACHED							
REVIEWED : APPROVED : VERIFIED :							

1.ELECTRICAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT	TEST RESULT	
1-1	Contact resistance	Dry circuit of DC 20mV	Less than $20 \text{ m}\Omega$	Sample	$20 \text{ m}\Omega$ max.
		max.100mA max.		1	$6.86~\mathrm{m}\Omega$
				2	$6.72~\mathrm{m}\Omega$
				3	$7.01~\mathrm{m}\Omega$
				4	$6.89~\mathrm{m}\Omega$
				5	$6.96~\mathrm{m}\Omega$
1-2	Dielectric strength	When applied AC 600V 1	No change	Sample	600 V 1 minute
		minute between adjacent terminal		1	Pass
				2	Pass
				3	Pass
				4	Pass
				5	Pass
1-3	Insulation resistance	When applied DC 500 V	More than $1000 \text{ M}\Omega$	Sample	$1000~\mathrm{M}\Omega$ min.
		between adjacent terminal or ground		1	$30*10^4 M\Omega$
	OI OI	or ground		2	$40*10^4 \text{M}\Omega$
				3	$30*10^4 \text{M}\Omega$
				4	30*10 ⁴ MΩ
				5	$30*10^4 \text{M}\Omega$

2. MECHANICAL PERFORMANCE:

2. MECHANICAE I ENGORMANCE.						
	ITEM	TEST CONDITION	REQUIREMENT	TEST RESULT		
2-1	Pin retention force	Push pin from insulator base	More than 200 gram	Sample	200 gram min.	
		at speed 25±3mm per minute	_	1	499 gram	
				2	497 gram	
				3	462 gram	
				4	512 gram	
				5	508 gram	

3. ENVIRONMENTAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT	TE	ST RESULT
3-1	Solderability	Soldering time: 5 ±0.5 sec.	Minimum:	Sample	90% of Immersed area
		Soldering pot:230 ±5	90% of immersed	1	Pass
		Soldering pot.250 L	area	2	Pass
				3	Pass
				4	Pass
				5	Pass
3-2	Resistance to soldering	Insulator: Glass filled	Appearance:	Sample	No damage
	heat	polyester UL 94V-0	No damage	1	Pass
		Soldering time: 5 ±0.5 sec.		2	Pass
		Soldering pot:260 ±5		3	Pass
		Boldering pol.200 ±		4	Pass
				5	Pass

		Insulator: Nylon 6T	Appearance:	Sample	No damage
		Max. Infrared Reflow	No damage	1	Pass
		Soldering temperature &	1 to dumage	2	Pass
		time: 230 for 60 sec		3	Pass
		260 for 10 sec		4	Pass
		200 101 10 sec		5	Pass
3-3	Heat aging	105 £ , 96 hours	Appearance:	Sample	No damage
		ĺ	No damage	1	Pass
				2	Pass
				3	Pass
				4	Pass
				5	Pass
3-4	Humidity	40 ±2 , 90-95%RH, 96	Appearance:	Sample	No damage
		hours measurement must be	No damage	1	Pass
		taken within 30 min. after tested		2	Pass
		lested		3	Pass
				4	Pass
				5	Pass
			Contact resistance: Less than twice of initial	Sample	< twice of initial
				1	$6.88~\mathrm{m}\Omega$
				2	$6.70~\mathrm{m}\Omega$
				3	$7.03~\mathrm{m}\Omega$
				4	$6.93~\mathrm{m}\Omega$
				5	6.92 mΩ
			Dielectric strength: To pass Para 1-2	Sample	Pass para 1-2
				1	Pass
				2	Pass
				3	Pass
				4	Pass
				5	Pass
3-5	Temperature cycling	One cycle consists of:	Appearance:	Sample	No damage
	2. Room 3. 85 ⁺³	1. -55^{+0}_{-3} , 30 min	No damage	1	Pass
		2. Room temp. 10-15 min		2	Pass
		=		3	Pass
		3. 85 ⁻³ , 30 min		4	Pass
		4. Room temp. 10-15 min		5	Pass
			Contact resistance: Less than twice of initial	Sample	< twice of initia
				1	6.87 mΩ
				2	6.74 mΩ
				3	7.02 mΩ
				4	6.91 mΩ
				5	6.98 mΩ

3-6	Salt spray	Temperature:35±3°C	Appearance:	Sample	No damage
		Solution:5±1%	No damage	1	Pass
		Spray time:48±4hours	1 to damage	2	Pass
		Measurement must be taken		3	Pass
		after water rinse		4	Pass
				5	Pass
			Contact resistance:	Sample	< twice of initial
			Less than twice of	1	$6.88~\mathrm{m}\Omega$
			initial	2	$6.73~\mathrm{m}\Omega$
				3	$7.06~\mathrm{m}\Omega$
				4	$6.95~\mathrm{m}\Omega$
				5	$6.97~\mathrm{m}\Omega$

4. AMBIENT TEMPERATURE RANGE

-40 to $+\ 105^{\circ}\text{C}$; $+\ 215^{\circ}\text{C}$ intermittent (Vapor Phase Solder Reflow) for SMT type.